



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of :  
Khandros et al. :  
Group Art Unit: :  
Serial No. 08/030,194 :  
Examiner: :  
Filed: April 28, 1993 :  
Date: July 27, 1993 :  
For: SEMICONDUCTOR CHIP :  
ASSEMBLIES, METHODS OF :  
MAKING SAME AND COMPONENTS: :  
FOR SAME :

\_\_\_\_\_  
Hon. Commissioner of Patents  
and Trademarks  
Washington, D.C. 20231

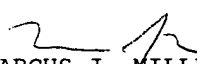
CERTIFICATION PURSUANT TO 37 C.F.R. { 1.97(e)(1)}

Sir:

Pursuant to 37 C.F.R. { 1.97(e)(1), undersigned counsel hereby certifies that each item of information contained in the accompanying Information Disclosure Statement was cited in a counterpart foreign patent office application to the above-referenced patent application not more than three months prior to the filing of said statement.

Respectfully submitted,

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